

DEMO MANUAL LB2223B

Multi-Footprint Mini Boards Lab Board LB2223B

INSTRUCTIONS

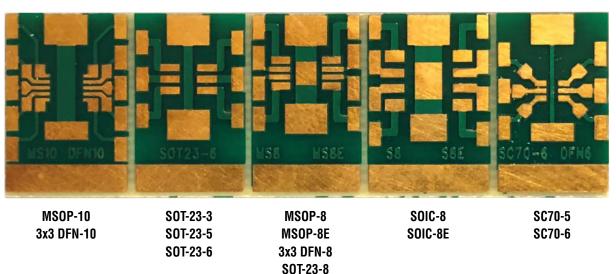
Each of the pin landing pads is connected to an edge pad to simplify wiring surface mount packages into other circuits. Additionally a center trace with pads at each end (and a center pad on the two boards on the right) is included for use as a ground trace.

Recommended use:

- 1. Apply a thin layer of solder to one of the corner pin landing pads (or the center pad, if using an exposed pad package, e.g. MSOP-8E, SOIC-8E, DFN-8).
- 2. Place the IC on the board, aligning the pins with the landing pads.
- 3. Place the tip of the soldering iron on top of the pin until the solder underneath melts and a connection is formed to the pad. Or, if using the center pad, heat that pad instead by placing one or two soldering irons on the connected center trace pads.
- 4. Solder the remaining pins.
- 5. Chip capacitors can be placed and soldered from a corner pad to a center trace ground pad.
- 6. Solder wires to the edge pads as needed to wire this lab board into a larger design. Double-sided tape can be used to secure the lab board to a larger board.

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BOARD PHOTO



Lab Board LB2223B Is Designed to Support Prototyping with the Following Packages:



ESD Caution

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

Legal Terms and Conditions

By using the evaluation board discussed herein (together with any tools, components documentation or support materials, the "Evaluation Board"), you are agreeing to be bound by the terms and conditions set forth below ("Agreement") unless you have purchased the Evaluation Board shall signify your acceptance of the Agreement. This Agreement and agreed to the Agreement. Your use of the Evaluation Board shall signify your acceptance of the Agreement. This Agreement and board unity ou have read and agreed to the Agreement. ADI hereby grants to Customer a free, limited, personal, temporary, non-exclusive, non-sublicensable, non-transferable license to use the Evaluation Board for any other purpose. Furthermore, the license grant and agrees that the Evaluation Board is provided for the sole and exclusive purpose referenced above, and agrees not to use the Evaluation Board is provided for the sole and exclusive purpose referenced above, and agrees not to use the Evaluation Board is provided for the sole and exclusive purpose referenced above, and agrees not to use the Evaluation Board is provided for the sole and exclusive purpose referenced above, and agrees not to use the Evaluation Board. As used herein, the term "Third Party" includes any entity other than ADI. Customer, atfiliates and in-house consultants. The Evaluation Board is NOT sold to Customer; altigrates and the revaluation Board are reserved by ADI. CONFIDENTIAITY. This Agreement and the Evaluation Board or termination of this Agreement, Customer any not discose or transfer any portion of the Evaluation Board are the evaluation Board are proved. Customer any not discose or transfer any portion of the Evaluation Board are the evaluation Board, including but not limited to soldering or any other activity that affects the material content of the Evaluation Board. As used herein, including but not limited to any other activity that affects the material content of the Evaluation Board. Sold and evaluation Board are the evaluation Board or termination of this

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